

View Online at <https://aerobasegroup.com/nsn/8040-00-130-7654>

Physical Form:

Paste

Quantity Within Each Unit Package:

1.000 gallons

Specific Usage Design:

For bonding semiconductors and transistors to heat sinks, fabricating heat sinks and for bonding electronic components

Special Features:

Resin only; thermally conductive; use with circalok 6010b, 6252, lord e-62s or ht-75 hardeners; service temperature range of minus 65 degrees c to plus 155 degrees c

Color:

Black

Material:

Plastic epoxy

Supplementary Features:

1 gallon can

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

No

Fiig:

A535p0